
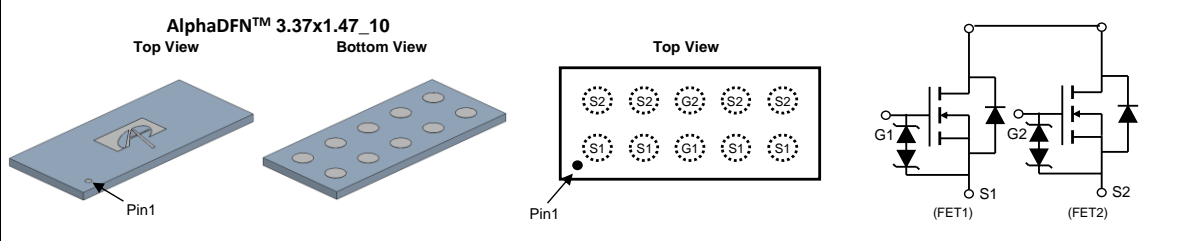


<p><b>General Description</b></p> <ul style="list-style-type: none"> <li>• Trench Power MOSFET technology</li> <li>• Low <math>R_{SS(ON)}</math></li> <li>• ESD protection</li> <li>• Common drain configuration for design simplicity</li> <li>• RoHS and Halogen-Free Compliant</li> </ul> <p><b>Applications</b></p> <ul style="list-style-type: none"> <li>• Battery protection switch</li> <li>• Type C - PD load switch</li> </ul>	<p><b>Product Summary</b></p> <table style="width: 100%; border: none;"> <tr> <td style="padding: 2px 5px;"><math>V_{SS}</math></td> <td style="text-align: right; padding: 2px 5px;">30V</td> </tr> <tr> <td style="padding: 2px 5px;"><math>R_{SS(ON)}</math> (at <math>V_{GS}=10V</math>)</td> <td style="text-align: right; padding: 2px 5px;">&lt; 7.3m<math>\Omega</math></td> </tr> <tr> <td style="padding: 2px 5px;"><math>R_{SS(ON)}</math> (at <math>V_{GS}=4.5V</math>)</td> <td style="text-align: right; padding: 2px 5px;">&lt; 10.2m<math>\Omega</math></td> </tr> </table> <p><b>Typical ESD protection</b> <span style="float: right;"><b>HBM Class 2</b></span></p> <div style="text-align: right; margin-top: 5px;">  </div>	$V_{SS}$	30V	$R_{SS(ON)}$ (at $V_{GS}=10V$ )	< 7.3m $\Omega$	$R_{SS(ON)}$ (at $V_{GS}=4.5V$ )	< 10.2m $\Omega$
$V_{SS}$	30V						
$R_{SS(ON)}$ (at $V_{GS}=10V$ )	< 7.3m $\Omega$						
$R_{SS(ON)}$ (at $V_{GS}=4.5V$ )	< 10.2m $\Omega$						



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOCA32317	AlphaDFN™ 3.37x1.47_10	Tape & Reel	5000

**Absolute Maximum Ratings**  $T_A=25^\circ\text{C}$  unless otherwise noted

Parameter	Symbol	Rating	Units
Source-Source Voltage	$V_{SS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Source Current(DC) <sup>Note1</sup>	$I_S$	17	A
Source Current(Pulse) <sup>Note2</sup>	$I_{SM}$	100	
Power Dissipation <sup>Note1</sup>	$P_D$	3.1	W
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	$^\circ\text{C}$

**Thermal Characteristics**

Parameter	Symbol	Typical	Units
Maximum Junction-to-Ambient	$R_{\theta JA}$	30	$^\circ\text{C/W}$
Maximum Junction-to-Ambient		40	$^\circ\text{C/W}$

**Note 1.**  $I_S$  rated value is based on bare silicon. Mounted on 70mmx70mm FR-4 board.  
**Note 2.** PW <10  $\mu\text{s}$  pulses, duty cycle 1% max.

**Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
B <sub>VSSS</sub>	Source-Source Breakdown Voltage	I <sub>S</sub> =250μA, V <sub>GS</sub> =0V Test Circuit 6	30			V
I <sub>SSS</sub>	Zero Gate Voltage Source Current	V <sub>SS</sub> =30V, V <sub>GS</sub> =0V Test Circuit 1 T <sub>J</sub> =55°C			1 5	μA
I <sub>GSS</sub>	Gate leakage current	V <sub>SS</sub> =0V, V <sub>GS</sub> =±20V Test Circuit 2			±10	μA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>SS</sub> =V <sub>GS</sub> , I <sub>S</sub> =250μA Test Circuit 3	1.1	1.5	2	V
R <sub>SS(ON)</sub>	Static Source to Source On-Resistance	V <sub>GS</sub> =10V, I <sub>S</sub> =5A Test Circuit 4	4.2	6	7.3	mΩ
		T <sub>J</sub> =125°C	6.3	9	11	
		V <sub>GS</sub> =4.5V, I <sub>S</sub> =5A Test Circuit 4	5.4	7.8	10.2	mΩ
g <sub>FS</sub>	Forward Transconductance	V <sub>SS</sub> =5V, I <sub>S</sub> =5A Test Circuit 3		37		S
V <sub>FSS</sub>	Forward Source to Source Voltage	I <sub>S</sub> =1A, V <sub>GS</sub> =0V Test Circuit 5		0.7	1	V
<b>DYNAMIC PARAMETERS</b>						
R <sub>g</sub>	Gate resistance	f=1MHz		208		Ω
<b>SWITCHING PARAMETERS</b>						
Q <sub>g</sub>	Total Gate Charge	V <sub>G1S1</sub> =10V, V <sub>SS</sub> =15V, I <sub>S</sub> =5A		50	70	nC
t <sub>D(on)</sub>	Turn-On DelayTime	V <sub>G1S1</sub> =10V, V <sub>SS</sub> =15V, R <sub>L</sub> =3Ω, R <sub>GEN</sub> =3Ω Test Circuit8		0.12		μs
t <sub>r</sub>	Turn-On Rise Time			0.23		μs
t <sub>D(off)</sub>	Turn-Off DelayTime			1.29		μs
t <sub>f</sub>	Turn-Off Fall Time			0.78		μs

APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO MAKE CHANGES TO PRODUCT SPECIFICATIONS WITHOUT NOTICE. IT IS THE RESPONSIBILITY OF THE CUSTOMER TO EVALUATE SUITABILITY OF THE PRODUCT FOR THEIR INTENDED APPLICATION. CUSTOMER SHALL COMPLY WITH APPLICABLE LEGAL REQUIREMENTS, INCLUDING ALL APPLICABLE EXPORT CONTROL RULES, REGULATIONS AND LIMITATIONS.

AOS' products are provided subject to AOS' terms and conditions of sale which are set forth at:  
[http://www.aosmd.com/terms\\_and\\_conditions\\_of\\_sale](http://www.aosmd.com/terms_and_conditions_of_sale)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

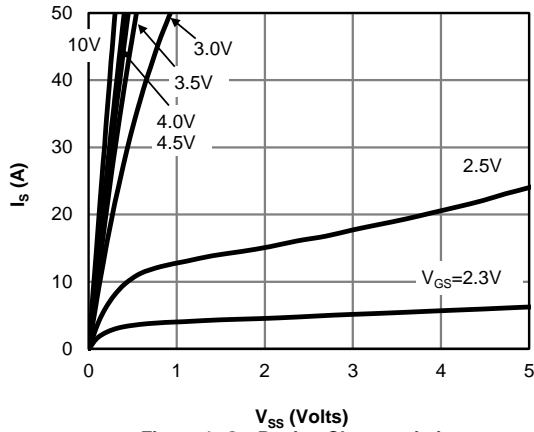


Figure 1: On-Region Characteristics

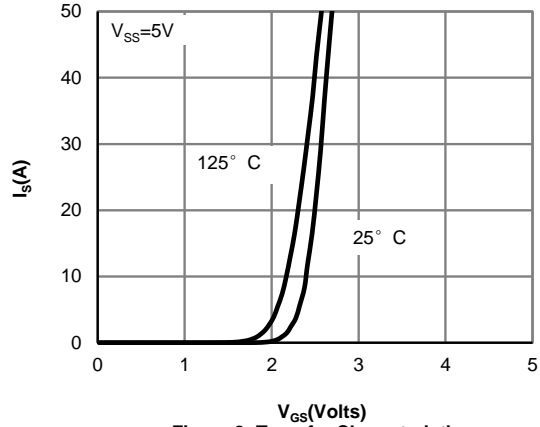


Figure 2: Transfer Characteristics

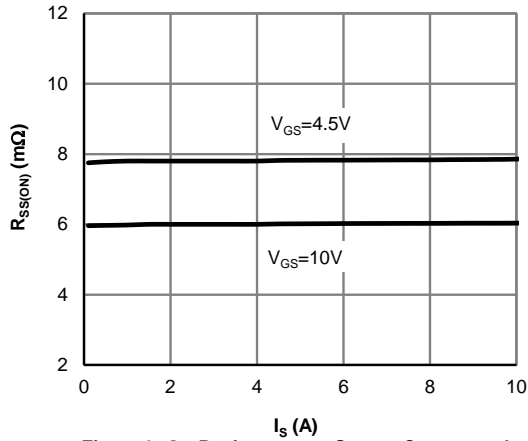


Figure 3: On-Resistance vs. Source Current and Gate Voltage

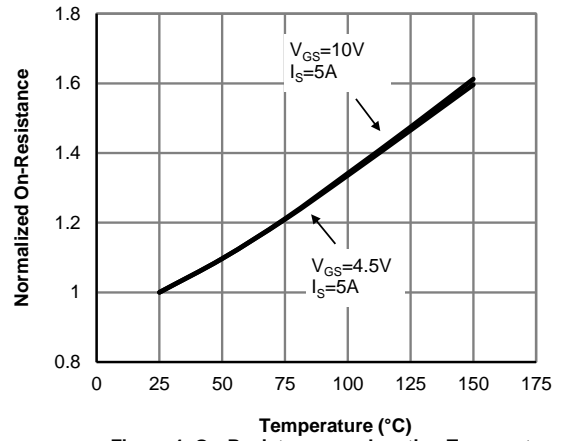


Figure 4: On-Resistance vs. Junction Temperature

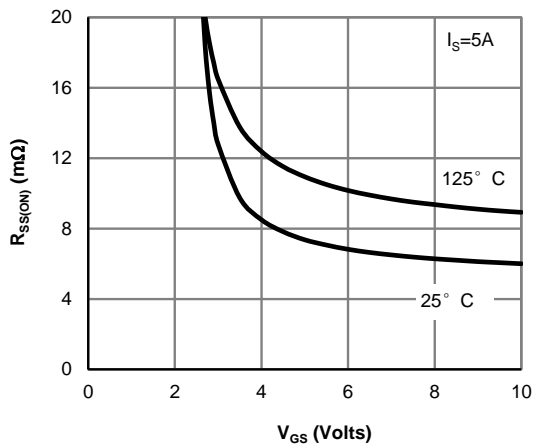


Figure 5: On-Resistance vs. Gate-Source Voltage

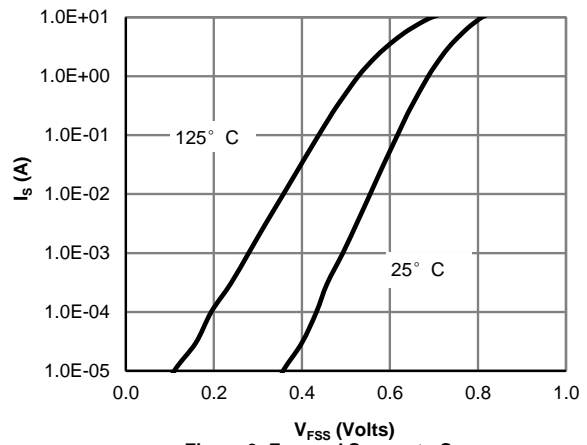


Figure 6: Forward Source to Source Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

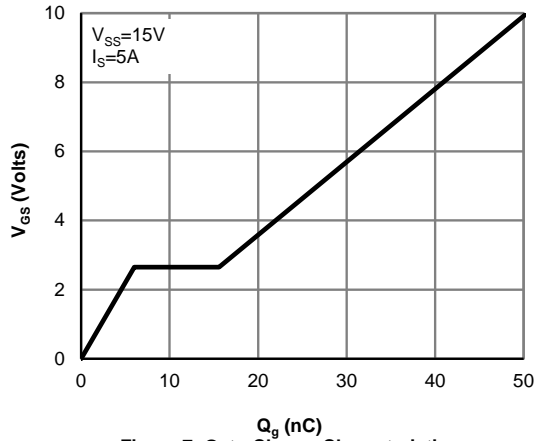


Figure 7: Gate-Charge Characteristics

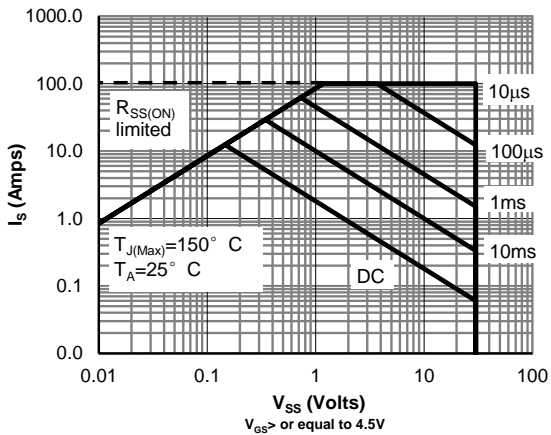


Figure 8: Maximum Forward Biased Safe Operating Area (Note1)

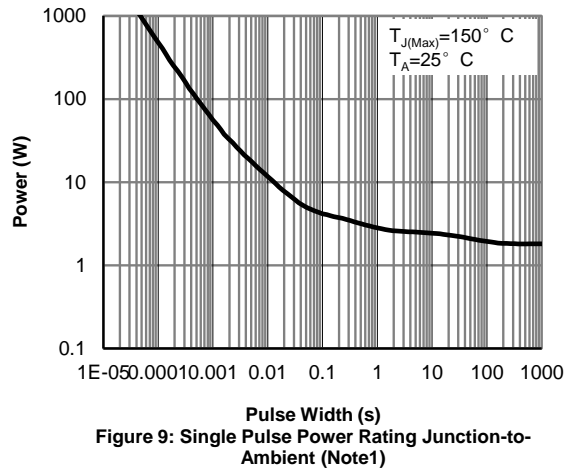


Figure 9: Single Pulse Power Rating Junction-to-Ambient (Note1)

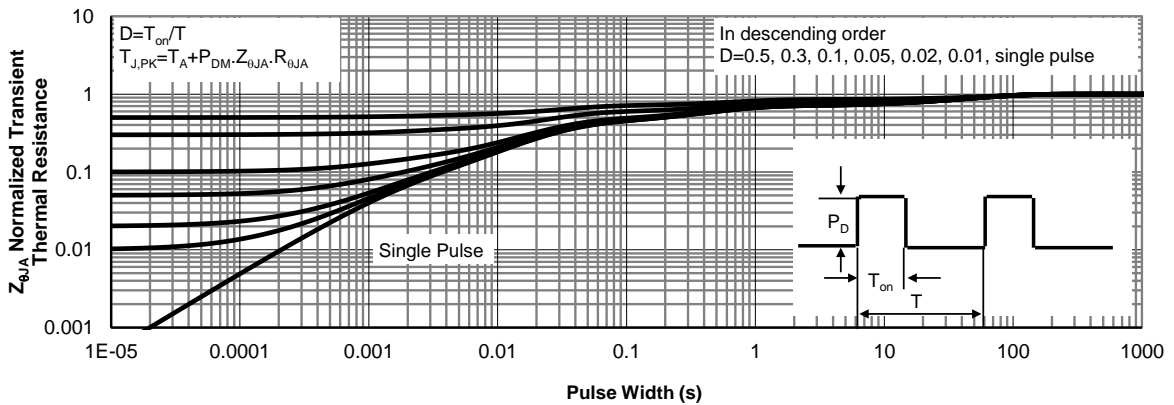


Figure 10: Normalized Maximum Transient Thermal Impedance (Note1)

